

General Description

The WST2339 is the highest performance trench P-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WST2339 meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

Product Summery

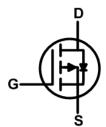
BVDSS	RDSON	ID
-20V	19mΩ	-7.1A

Applications

- High Frequency Point-of-Load Synchronous
 Small power switching for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

SOT-23N Pin Configuration





Absolute Maximum Ratings

Symbol	Parameter	Rating	Units	
V_{DS}	Drain-Source Voltage	-20	V	
V_{GS}	Gate-Source Voltage	±12	V	
I _D @T _c =25℃	Continuous Drain Current, V _{GS} @ -4.5V ¹	Α		
I _D @T _c =70°C	Continuous Drain Current, V _{GS} @ -4.5V ¹	-6.0	А	
I _{DM}	Pulsed Drain Current ²	-20	Α	
P _D @T _A =25°C	Total Power Dissipation ³	1.4	W	
T _{STG}	Storage Temperature Range -55 to 150		$^{\circ}$	
T _J	Operating Junction Temperature Range	-55 to 150	$^{\circ}$	

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-ambient ¹		125	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹		80	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-20			V
$\triangle BV_{DSS}/\triangle T_{J}$	BVDSS Temperature Coefficient	Reference to 25℃ , I _D =-1mA		-0.01		V/°C
	Static Drain-Source On-Resistance ²	V _{GS} =-4.5V , I _D =-4A		17	19	mΩ
R _{DS(ON)}		V _{GS} =-2.5V , I _D =-2A		21	25	
		V _{GS} =-1.8V , I _D =-1.5A		30	35	
V _{GS(th)}	Gate Threshold Voltage	V V 1 050 A	-0.5	-0.5	-1.0	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_D=-250uA$		2.96		mV/℃
	Drain Source Leakage Current	V _{DS} =-16V , V _{GS} =0V , T _J =25℃			-1	uA
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-16V , V _{GS} =0V , T _J =55°C			-5	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 8V$, V_{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =-5V , I _D =-4A		35		S
Qg	Total Gate Charge (-4.5V)	V _{DS} =-15V , V _{GS} =-4.5V , I _D =-4A		32	38.2	nC
Q_{gs}	Gate-Source Charge			6.8	9.0	
Q_{gd}	Gate-Drain Charge			6.9	9.1	
T _{d(on)}	Turn-On Delay Time	V_{DD} =-10V , V_{GS} =-4.5V , R_{G} =3.3 Ω		20	38.4	
Tr	Rise Time			60	106	
T _{d(off)}	Turn-Off Delay Time			300	398	ns
T _f	Fall Time			75	142	
C _{iss}	Input Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz		2000		
Coss	Output Capacitance			800		pF
C _{rss}	Reverse Transfer Capacitance			620		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current ^{1,4}	V =V =0V Force Current			-7.1	Α
I _{SM}	Pulsed Source Current ^{2,4}	V _G =V _D =0V , Force Current			-40	Α
V _{SD}	Diode Forward Voltage ²	V_{GS} =0V , I_{S} =-1A , T_{J} =25 $^{\circ}$ C			-1.1	V
t _{rr}	Reverse Recovery Time			22		nS
Q _{rr}	Reverse Recovery Charge	lF=-4A,dl/dt=100A/µs,T _J =25℃		10		nC

Note:

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3.The power dissipation is limited by 150 ℃ junction temperature
- 4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

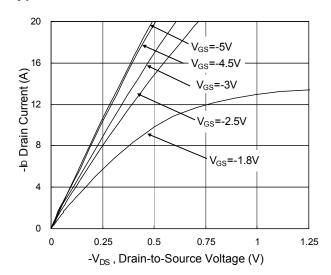
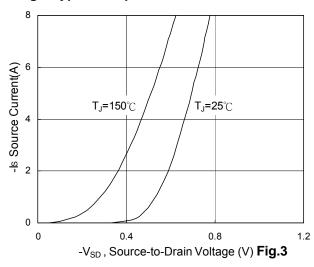


Fig.1 Typical Output Characteristics



Forward Characteristics Of Reverse

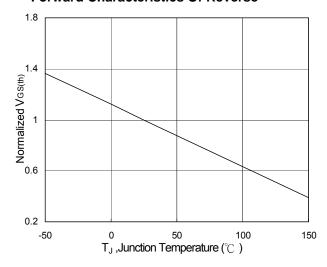


Fig.5 Normalized V_{GS(th)} vs. T_J

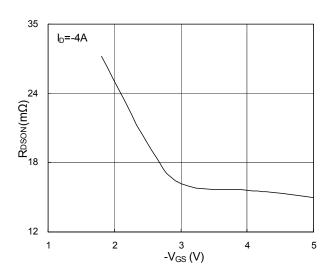


Fig.2 On-Resistance vs. Gate-Source

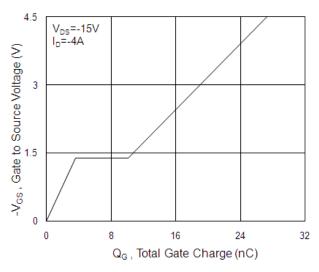


Fig.4 Gate-Charge Characteristics

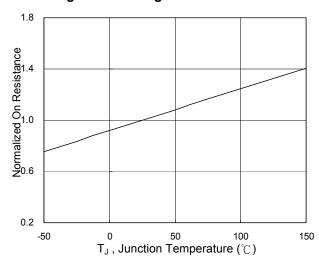
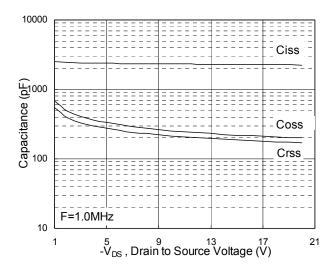


Fig.6 Normalized R_{DSON} vs. T_J





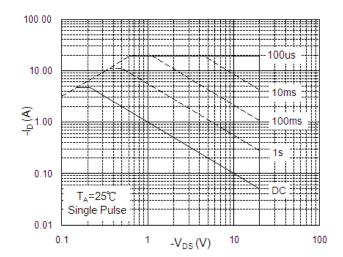


Fig.7 Capacitance

Fig.8 Safe Operating Area

Qg

Qgd

Charge

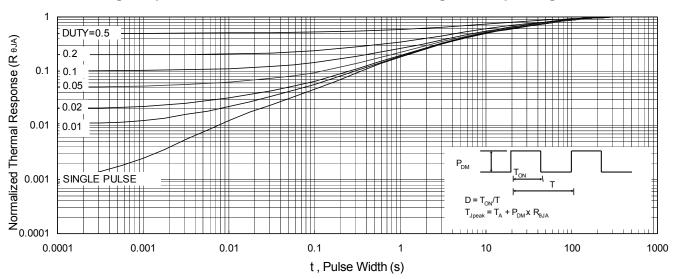
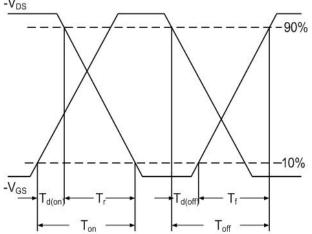


Fig.9 Normalized Maximum Transient Thermal Impedance

-V_{GS}

4.5V

Qgs







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